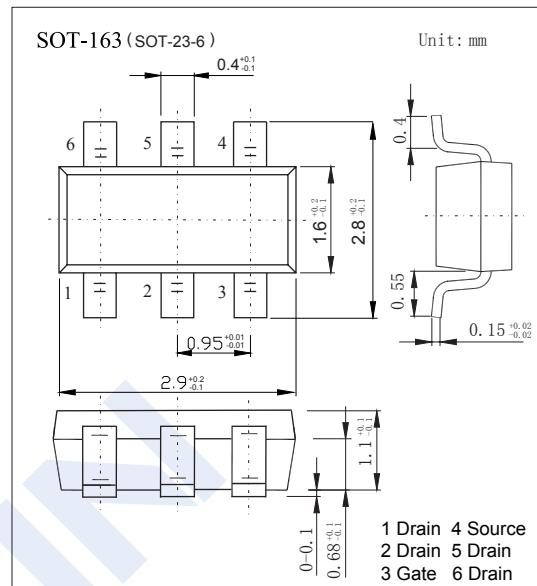
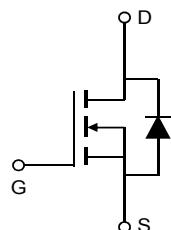


N-Channel MOSFET

AO6424A (KO6424A)

■ Features

- $V_{DS} (V) = 30V$
- $I_D = 6.5 A (V_{GS} = 10V)$
- $R_{DS(ON)} < 35m\Omega (V_{GS} = 10V)$
- $R_{DS(ON)} < 48m\Omega (V_{GS} = 4.5V)$



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current	I_D	6.5	A
		5	
Pulsed Drain Current	I_{DM}	27	W
Power Dissipation	P_D	2.5	
		1.5	
Thermal Resistance.Junction- to-Ambient	R_{thJA}	50	$^\circ C/W$
		85	
Thermal Resistance.Junction- to-Lead	R_{thJL}	30	$^\circ C$
Junction Temperature	T_J	150	
Storage Temperature Range	T_{stg}	-55 to 150	

N-Channel MOSFET

AO6424A (KO6424A)

■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V_{DSS}	$I_D=250 \mu\text{A}, V_{GS}=0\text{V}$	30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=30\text{V}, V_{GS}=0\text{V}$			1	μA
		$V_{DS}=30\text{V}, V_{GS}=0\text{V}, T_J=55^\circ\text{C}$			5	
Gate-Body Leakage Current	I_{GSS}	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			± 100	nA
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=250 \mu\text{A}$	1.2		2.4	V
Static Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS}=10\text{V}, I_D=5\text{A}$			35	$\text{m}\Omega$
		$V_{GS}=10\text{V}, I_D=5\text{A}, T_J=125^\circ\text{C}$			53	
		$V_{GS}=4.5\text{V}, I_D=4\text{A}$			48	
Forward Transconductance	g_{FS}	$V_{DS}=5\text{V}, I_D=5\text{A}$		8		S
Input Capacitance	C_{iss}	$V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$		270		pF
Output Capacitance	C_{oss}			50		
Reverse Transfer Capacitance	C_{rss}			35		
Gate Resistance	R_g	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	1.4		4.2	Ω
Total Gate Charge (10V)	Q_g	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, I_D=5\text{A}$		6.3	12	nC
Total Gate Charge (4.5V)				3.2	8	
Gate Source Charge	Q_{gs}			0.65		
Gate Drain Charge	Q_{gd}			1.75		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, R_L=3 \Omega, R_G=3 \Omega$		3		ns
Turn-On Rise Time	t_r			2.5		
Turn-Off Delay Time	$t_{d(off)}$			17.5		
Turn-Off Fall Time	t_f			2.5		
Body Diode Reverse Recovery Time	t_{rr}	$I_F= 5\text{A}, dI/dt= 100\text{A/us}$		10		nC
Body Diode Reverse Recovery Charge	Q_{rr}			2.3		
Maximum Body-Diode Continuous Current	I_s				3	A
Diode Forward Voltage	V_{SD}	$I_s=1\text{A}, V_{GS}=0\text{V}$			1	V

* The static characteristics in Figures 1 to 6 are obtained using <300us pulses, duty cycle 0.5% max.

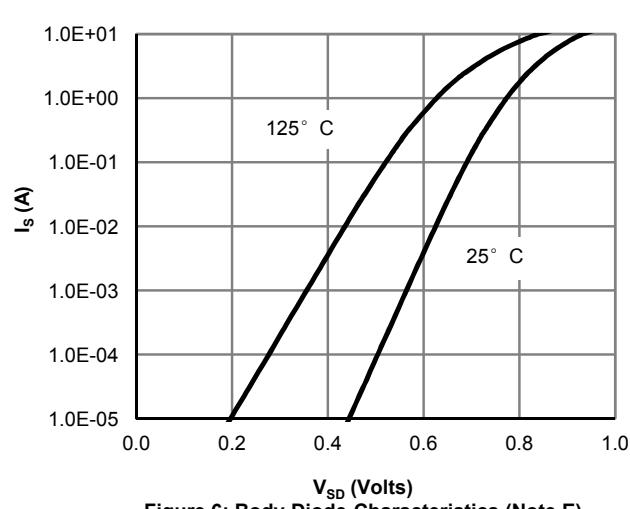
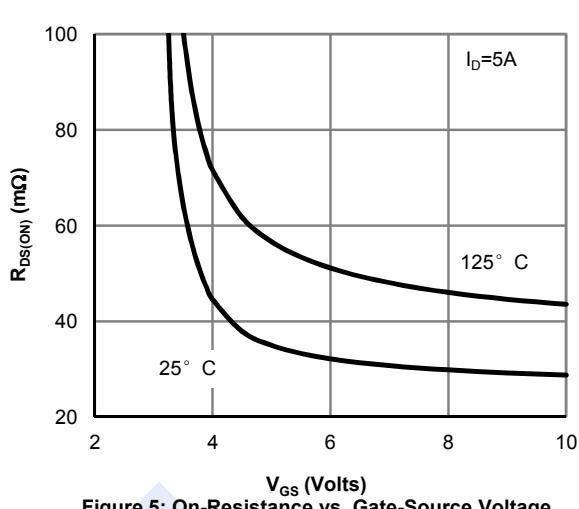
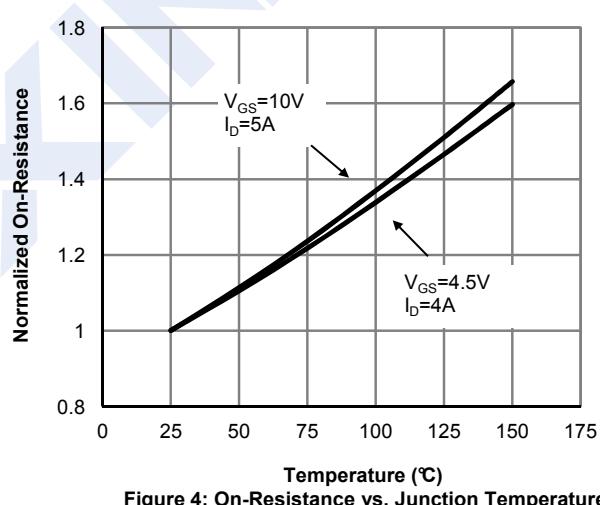
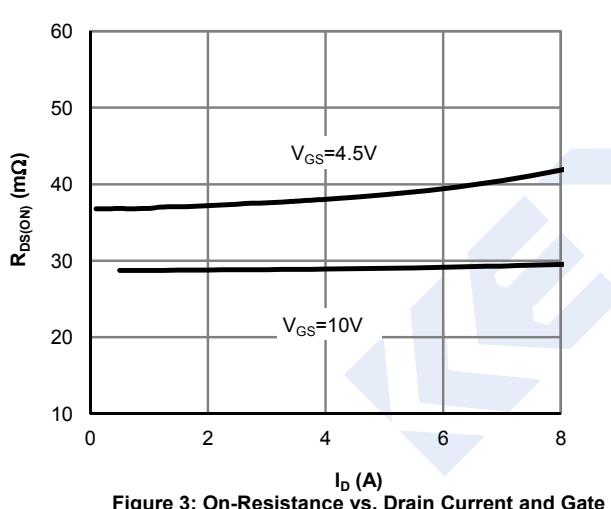
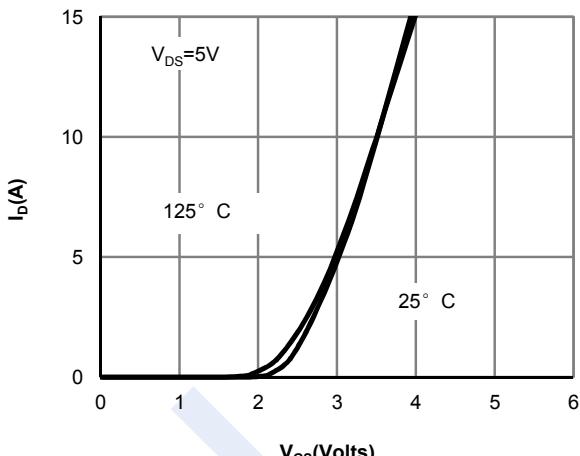
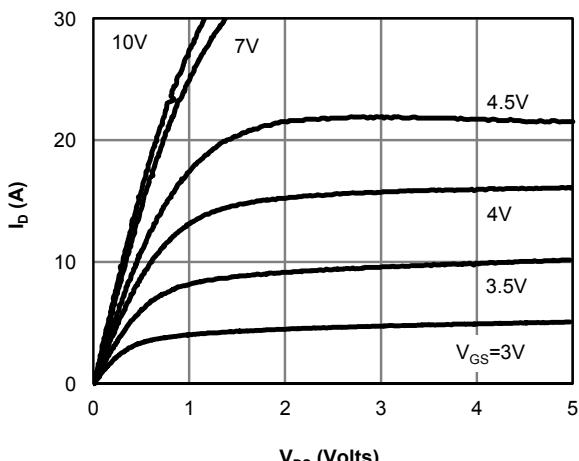
■ Marking

Marking	4T**
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N-Channel MOSFET

AO6424A (KO6424A)

■ Typical Characteristics



N-Channel MOSFET

AO6424A (KO6424A)

■ Typical Characteristics

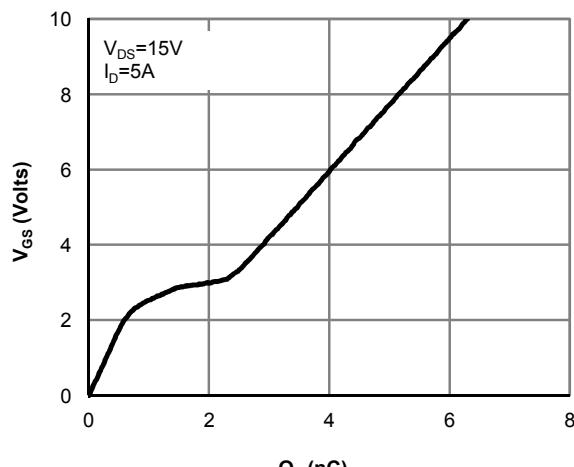


Figure 7: Gate-Charge Characteristics

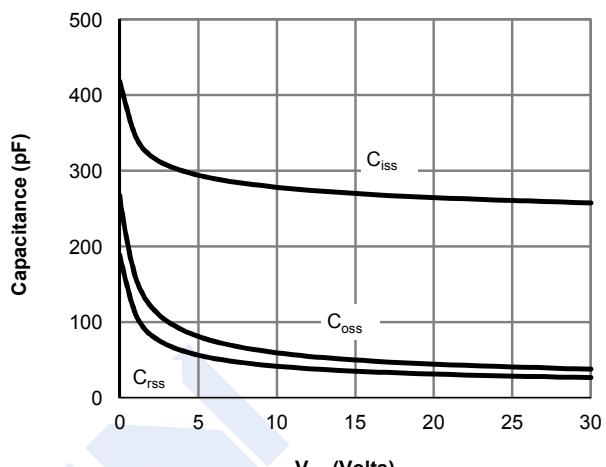


Figure 8: Capacitance Characteristics

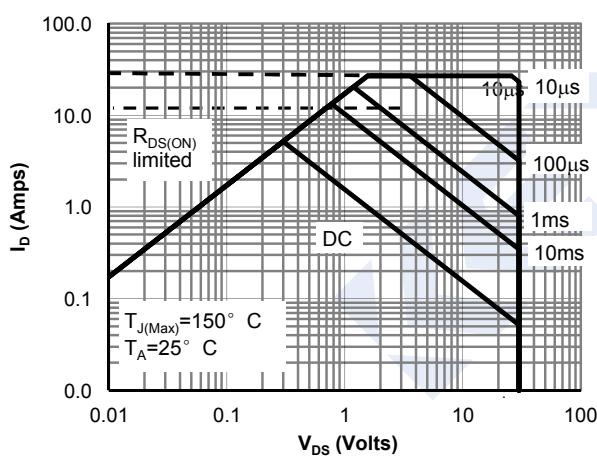


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

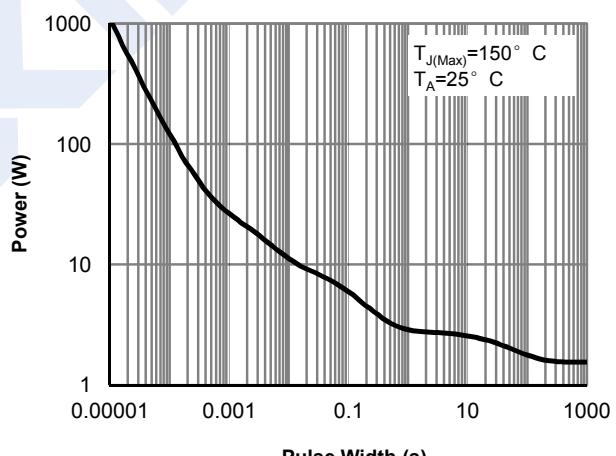


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

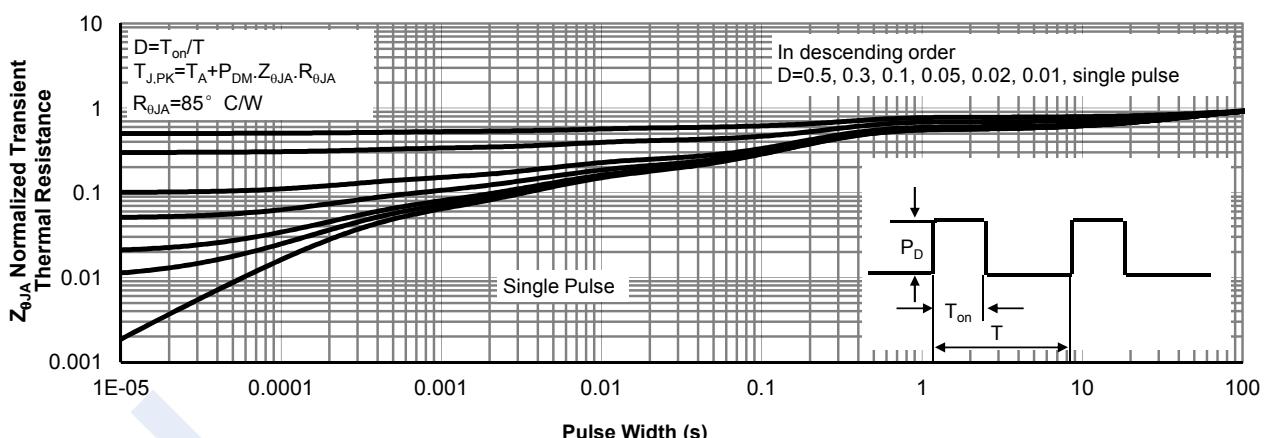


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)